Unit: mm

TOSHIBA Photocoupler Photorelay

TLP192A

Telecommunications
Measurement and Control Equipment
Data Acquisition System
Measurement Equipment

The Toshiba TLP192A consists of a gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET in a 6-pin SOP package.

Because of the low offset voltage at turn-on, this photorelay is suitable for analog signal switching, eg. micro signal scan circuit of data acquisition system, subscriber circuit of digital exchange.

This photorelay has higher output current rating than phototransistor-type photocoupler; hence, it is suitable for use as On/Off control for high current.

- 6-pin SOP (2.54SOP6): Height = 2.1 mm, pitch = 2.54 mm
- Normally open (1-form-A) device
- Peak off-state voltage: 60 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 400 mA (max)
- On-state resistance: 2Ω (max)
- Isolation voltage: 1500 Vrms (min)
- UL approved: UL1577, File No.E67349
- cUL approved :CSA Component Acceptance Service No. 5A, File No.E67349

6.3±0.25 0.4±0.1 JEDEC

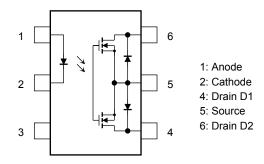
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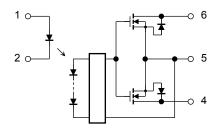
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Weight: 0.13 g (typ.)

Pin Configuration (top view)



Schematic



Start of commercial production 2002/03

TLP192A



Absolute Maximum Ratings (Ta = 25°C)

Characteristics			Symbol	Symbol Rating	
	Forward curre	ent	I _F	50	mA
	Forward curre	ent derating (Ta ≥ 25°C)	ΔI _F /°C	-0.5	mA/°C
	Peak forward (100 μs pulse		I _{FP}	1	А
LED	Reverse volta	ge	V _R	5	V
	Diode power	dissipation	P _D	50	mW
	Diode power	dissipation derating (Ta >25°C)	ΔP _D /°C	-0.5	mW/°C
	Junction temp	perature	Tj	125	°C
	Off-state outp	ut terminal voltage	V _{OFF}	60	V
	On-state current	A connection		400	
		B connection	I _{ON}	400	mA
		C connection		800	
.	Forward current derating (Ta ≥ 25°C)	A connection		-4.0	
Detector		B connection	ΔI _{ON} /°C	-4.0	mA/°C
		C connection		-8.0	
	Output power	dissipation	Po	256	mW
	Output power	dissipation derating (Ta ≥ 25°C)	ΔP _O / °C	-2.56	mW / °C
	Junction temp	perature	Tj	125	°C
Storage temperature			T _{stg}	T _{stg} –55 to 125	
Operating temperature			T _{opr}	-40 to 85	°C
Lead soldering temperature (10 s)			T _{sol}	260	°C
Isolation voltage (AC, 1 minute, R.H. ≤ 60%) (Note 1)			BV _S	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: LED pins are shorted together. Detector pins are also shorted together.

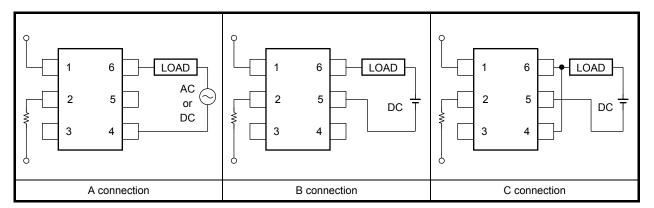
Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V_{DD}	_	_	48	V
Forward current	l _F	5	7.5	25	mA
On-state current	I _{ON}	_	_	400	mA
Operating temperature	T _{opr}	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.



Circuit Connections



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Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	V_{F}	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse voltage	I _R	V _R = 5 V	_	_	10	μА
	Capacitance between terminals	C _T	V _F = 0 V, f = 1 MHz	_	30	_	pF
Detector	Off-state current	l _{OFF}	V _{OFF} = 60 V	_	_	1	μА
	Capacitance between terminals	C _{OFF}	V = 0 V, f = 1 MHz		130	_	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		I _{FT}	I _{ON} = 400 mA	_	1.6	3	mA
Return LED current		I _{FC}	I _{OFF} = 100 μA	0.1	_	_	mA
	A connection		I _{ON} = 400 mA, I _F = 5 mA	_	1	2	
On-state resistance	B connection	R _{ON}	I _{ON} = 400 mA, I _F = 5 mA	_	0.5	1	Ω
	C connection		I _{ON} = 800 mA, I _F = 5 mA		0.25	_	

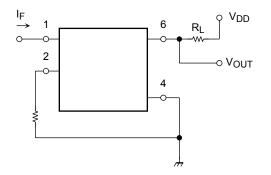
Isolation Characteristics (Ta = 25°C)

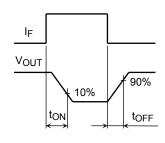
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	V _S = 0 V, f = 1 MHz	_	8.0	_	pF
Isolation resistance	R _S	V _S = 500 V, R.H. ≤ 60%	5 × 10 ¹⁰	10 ¹⁴	_	Ω
	BVS	AC, 1 minute	1500	_	_	Vrms
Isolation voltage		AC, 1 second, in oil	_	3000	_	
		DC, 1 minute, in oil	_	3000	_	Vdc

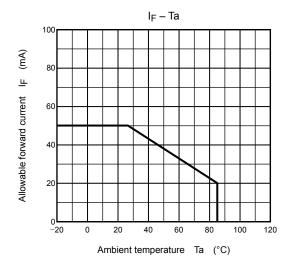
Switching Characteristics (Ta = 25°C)

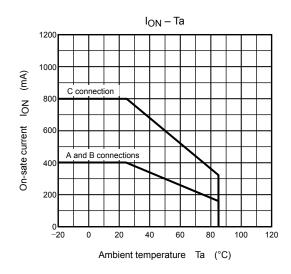
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t _{ON}	$R_L = 200 \Omega$ (Note 2)	_	8.0	2	ma
Turn-off time	toff	$V_{DD} = 20 \text{ V, I}_{F} = 5 \text{ mA}$		0.1	0.5	ms

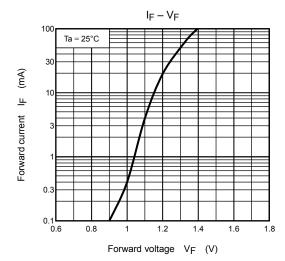
Note 2: Switching time test circuit

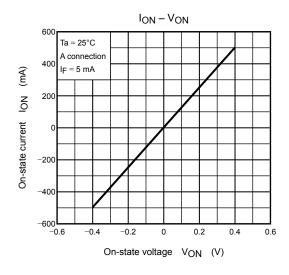


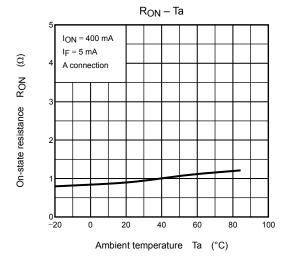


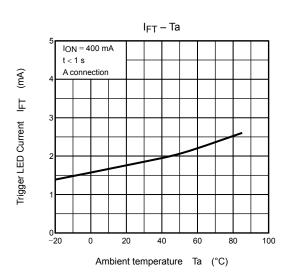


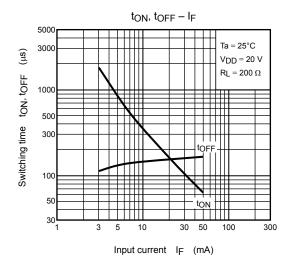


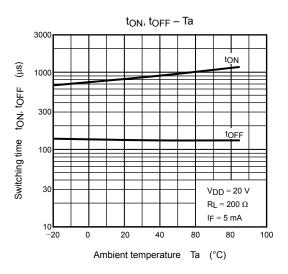


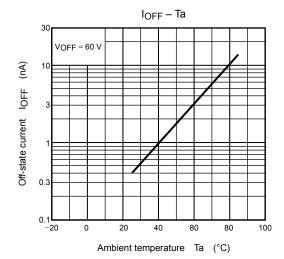












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